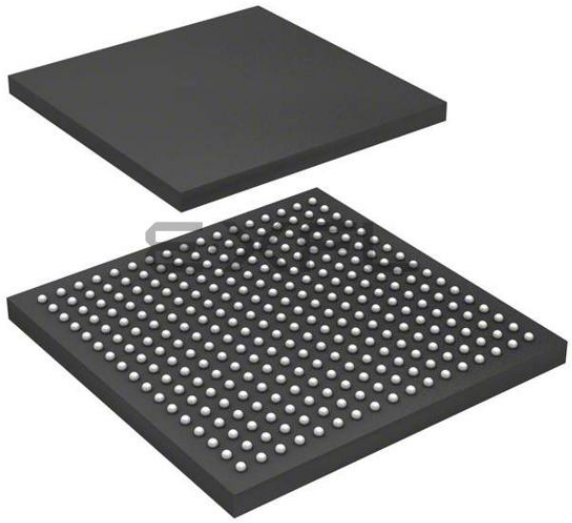

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Understanding Embedded - Microprocessors

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

Applications of Embedded - Microprocessors

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details	
Product Status	Active
Core Processor	ARM® Cortex®-A5
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	500MHz
Co-Processors/DSP	Multimedia; NEON™ MPE
RAM Controllers	LPDDR1, LPDDR2, LPDDR3, DDR2, DDR3, DDR3L, QSPI
Graphics Acceleration	Yes
Display & Interface Controllers	Keyboard, LCD, Touchscreen
Ethernet	10/100Mbps (1)
SATA	-
USB	USB 2.0 + HSIC
Voltage - I/O	3.3V
Operating Temperature	-40°C ~ 85°C (TA)
Security Features	ARM TZ, Boot Security, Cryptography, RTIC, Secure Fusebox, Secure JTAG, Secure Memory, Secure RTC
Package / Case	289-TFBGA
Supplier Device Package	289-TFBGA (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atsama5d27c-d1g-cur

Table of Contents

1. Features

- ARM Cortex-A5 core
  - ARMv7-A architecture
  - ARM TrustZone
  - NEON™ Media Processing Engine
  - Up to 500 MHz
  - ETM/ETB 8 Kbytes
- Memory Architecture
  - Memory Management Unit
  - 32-Kbyte L1 data cache, 32-Kbyte L1 instruction cache
  - 128-Kbyte L2 cache configurable to be used as an internal SRAM
  - DDR2-SDRAM memory up to 1 Gb
  - One 128-Kbyte scrambled internal SRAM
  - One 160-Kbyte internal ROM
    - 64-Kbyte scrambled and maskable ROM embedding boot loader/Secure boot loader
    - 96-Kbyte unscrambled, unmaskable ROM for NAND Flash BCH ECC table
  - High-bandwidth scramblable 16-bit Double Data Rate (DDR) multiport dynamic RAM controller supporting Winbond DDR2-SDRAM up to 1 Gb , including “on-the-fly” encryption/decryption path
  - 8-bit SLC/MLC NAND controller, with up to 32-bit Error Correcting Code (PMECC)
- System running up to 166 MHz
  - Reset controller, shutdown controller, periodic interval timer, independent watchdog timer and secure Real-Time Clock (RTC) with clock calibration
  - One 600 to 1200 MHz PLL for the system and one 480 MHz PLL optimized for USB high speed
  - Digital fractional PLL for audio (11.2896 MHz and 12.288 MHz)
  - Internal low-power 12 MHz RC and 32 KHz typical RC
  - Selectable 32.768-Hz low-power oscillator and 8 to 24 MHz oscillator
  - 51 DMA Channels including two 16-channel 64-bit Central DMA Controllers
  - 64-bit Advanced Interrupt Controller (AIC)
  - 64-bit Secure Advanced Interrupt Controller (SAIC)
  - Three programmable external clock signals
- Low-Power Modes
  - Ultra Low-power mode with fast wakeup capability
  - Low-power Backup mode with 5-Kbyte SRAM and SleepWalking™ features
    - Wakeup from up to nine wakeup pins, UART reception, analog comparison
    - Fast wakeup capability
    - Extended Backup mode with DDR2-SDRAM in Self-Refresh mode
- Peripherals
  - LCD TFT controller up to 1024x768, with four overlays, rotation, post-processing and alpha blending, 24-bit parallel RGB

  - ITU-R BT. 601/656/1120 Image Sensor Controller (ISC) supporting up to 5 M-pixel sensors with a parallel 12-bit interface for Raw Bayer, YCbCr, Monochrome and JPEG-compressed sensor interface
  - Two Synchronous Serial Controllers (SSC), two Inter-IC Sound Controllers (I2SC), and one Stereo Class D amplifier
  - One Peripheral Touch Controller (PTC) with up to 8 X-lines and 8 Y-lines (64-channel capacitive touch)
  - One Pulse Density Modulation Interface Controller (PDMIC)
  - One USB high-speed device port (UDPHS) and one USB high-speed host port or two USB high-speed host ports (UHPHS)
  - One USB high-speed host port with a High-Speed Inter-Chip (HSIC) interface
  - One 10/100 Ethernet MAC (GMAC)
    - Energy efficiency support (IEEE 802.3az standard)
    - Ethernet AVB support with IEEE802.1AS time stamping
    - IEEE802.1Qav credit-based traffic-shaping hardware support
    - IEEE1588 Precision Time Protocol (PTP)
  - Two high-speed memory card hosts:
    - SDMMC0: SD 3.0, eMMC 4.51, 8 bits
    - SDMMC1: SD 2.0, eMMC 4.41, 4 bits only
  - Two master/slave Serial Peripheral Interfaces (SPI)
  - Two Quad Serial Peripheral Interfaces (QSPI)
  - Five FLEXCOMs (USART, SPI and TWI)
  - Five UARTs
  - Two master CAN-FD (MCAN) controllers with SRAM-based mailboxes, and time- and event-triggered transmission
  - One Rx only UART in backup area (RXLP)
  - One analog comparator (ACC) in backup area
  - Two 2-wire interfaces (TWIHS) up to 400 Kbits/s supporting the I^2C protocol and SMBUS (TWIHS)
  - Two 3-channel 32-bit Timer/Counters (TC), supporting basic PWM modes
  - One full-featured 4-channel 16-bit Pulse Width Modulation (PWM) controller
  - One 12-channel, 12-bit, Analog-to-Digital Converter (ADC) with Resistive TouchScreen capability
- Safety
  - Zero-power Power-On Reset (POR) cells
  - Main crystal clock failure detector
  - Write-protected registers
  - Integrity Check Monitor (ICM) based on SHA256
  - Memory Management Unit
  - Independent watchdog
- Security
  - 5 Kbytes of internal scrambled SRAM:
    - 1 Kbyte non-erasable on tamper detection
    - 4 Kbytes erasable on tamper detection
  - 256 bits of scrambled and erasable registers

2. DDR2-SDRAM Features

- Power Supply: V_{DD}, V_{DDQ} = 1.8 V ±0.1 V
- Double Data Rate architecture: two data transfers per clock cycle
- CAS Latency: 3
- Burst Length: 8
- Bi-directional, differential data strobes (DQS and DQSN) are transmitted/received with data
- Edge-aligned with Read data and center-aligned with Write data
- DLL aligns DQ and DQS transitions with clock
- Differential clock inputs (CLK and CLKN)
- Data masks (DM) for write data
- Commands entered on each positive CLK edge, data and data mask are referenced to both edges of DQS
- Auto-refresh and Self-refresh modes
- Precharged Powerdown and Active Powerdown
- Write Data Mask
- Write Latency = Read Latency - 1 (WL = RL - 1)
- Interface: SSTL_18

5. Package and Ballout

The SAMA5D2 SIP is available in the packages listed below.

Important: SAMA5D2 SIP devices are not pin-to-pin compatible with SAMA5D2 devices.

For mechanical characteristics of the TFBGA196, refer to the SAMA5D2 Series Datasheet, ref. no. DS60001476, available via www.microchip.com.

For mechanical characteristics of the TFBGA289, see Mechanical Characteristics.

Table 5-1. Packages

Package Name	Ball Count	Ball Pitch	Package Size
TFBGA196	196	0.75 mm	11 x 11 (mm)
TFBGA289	289	0.8 mm	14 x 14 (mm)

Table 5-2. Ball Description

289-ball BGA	196-ball BGA	Power Rail	I/O Type	Primary		Alternate		PIO Peripheral				Reset State (Signal, Dir, PU, PD, HiZ, ST)[1]
				Signal	Dir	Signal	Dir	Func	Signal	Dir	IO Set	
U13	M8	VDDSDMMC	GPIO_EMMC	PA0	I/O	–	–	A	SDMMC0_CK	I/O	1	PIO, I, PU, ST
								B	QSPI0_SCK	O	1	
								F	D0	I/O	2	
N7	F7	VDDSDMMC	GPIO_EMMC	PA1	I/O	–	–	A	SDMMC0_CMD	I/O	1	PIO, I, PU, ST
								B	QSPI0_CS	O	1	
								F	D1	I/O	2	
U14	L8	VDDSDMMC	GPIO_EMMC	PA2	I/O	–	–	A	SDMMC0_DAT0	I/O	1	PIO, I, PU, ST
								B	QSPI0_IO0	I/O	1	
								F	D2	I/O	2	
T13	G8	VDDSDMMC	GPIO_EMMC	PA3	I/O	–	–	A	SDMMC0_DAT1	I/O	1	PIO, I, PU, ST
								B	QSPI0_IO1	I/O	1	
								F	D3	I/O	2	
U15	K8	VDDSDMMC	GPIO_EMMC	PA4	I/O	–	–	A	SDMMC0_DAT2	I/O	1	PIO, I, PU, ST
								B	QSPI0_IO2	I/O	1	
								F	D4	I/O	2	
U16	P9	VDDSDMMC	GGPIO_EMMC	PA5	I/O	–	–	A	SDMMC0_DAT3	I/O	1	PIO, I, PU, ST
								B	QSPI0_IO3	I/O	1	
								F	D5	I/O	2	
U17	P10	VDDSDMMC	GPIO_EMMC	PA6	I/O	–	–	A	SDMMC0_DAT4	I/O	1	PIO, I, PU, ST
								B	QSPI1_SCK	O	1	
								D	TIOA5	I/O	1	
								E	FLEXCOM2_IO0	I/O	1	

289-ball BGA	196-ball BGA	Power Rail	I/O Type	Primary		Alternate		PIO Peripheral				Reset State (Signal, Dir, PU, PD, HiZ, ST)[1]
				Signal	Dir	Signal	Dir	Func	Signal	Dir	IO Set	
								F	D6	I/O	2	
R11	P11	VDDSDMMC	GPIO_EMMC	PA7	I/O	–	–	A	SDMMC0_DAT5	I/O	1	PIO, I, PU, ST
								B	QSPI1_IO0	I/O	1	
								D	TIOB5	I/O	1	
								E	FLEXCOM2_IO1	I/O	1	
								F	D7	I/O	2	
R9	K9	VDDSDMMC	GPIO_EMMC	PA8	I/O	–	–	A	SDMMC0_DAT6	I/O	1	PIO, I, PU, ST
								B	QSPI1_IO1	I/O	1	
								D	TCLK5	I	1	
								E	FLEXCOM2_IO2	I/O	1	
								F	NWE/NANDWE	O	2	
P8	J9	VDDSDMMC	GPIO_EMMC	PA9	I/O	–	–	A	SDMMC0_DAT7	I/O	1	PIO, I, PU, ST
								B	QSPI1_IO2	I/O	1	
								D	TIOA4	I/O	1	
								E	FLEXCOM2_IO3	O	1	
								F	NCS3	O	2	
R10	N14	VDDSDMMC	GPIO_EMMC	PA10	I/O	–	–	A	SDMMC0_RSTN	O	1	PIO, I, PU, ST
								B	QSPI1_IO3	I/O	1	
								D	TIOB4	I/O	1	
								E	FLEXCOM2_IO4	O	1	
								F	A21/NANDALE	O	2	
P15	N13	VDDIOP1	GPIO	PA11	I/O	–	–	A	SDMMC0_1V8SEL	O	1	PIO, I, PU, ST
								B	QSPI1_CS	O	1	
								D	TCLK4	I	1	
								F	A22/NANDCLE	O	2	
N17	L12	VDDIOP1	GPIO	PA12	I/O	–	–	A	SDMMC0_WP	I	1	PIO, I, PU, ST
								B	IRQ	I	1	
								F	NRD/NANDOE	O	2	
P16	M14	VDDIOP1	GPIO	PA13	I/O	–	–	A	SDMMC0_CD	I	1	PIO, I, PU, ST
								E	FLEXCOM3_IO1	I/O	1	
								F	D8	I/O	2	
M17	J10	VDDIOP1	GPIO_QSPI	PA14	I/O	–	–	A	SPI0_SPCK	I/O	1	PIO, I, PU, ST
								B	TK1	I/O	1	
								C	QSPI0_SCK	O	2	
								D	I2SC1_MCK	O	2	
								E	FLEXCOM3_IO2	I/O	1	
								F	D9	I/O	2	
N16	L14	VDDIOP1	GPIO	PA15	I/O	–	–	A	SPI0_MOSI	I/O	1	PIO, I, PU, ST
								B	TF1	I/O	1	
								C	QSPI0_CS	O	2	
								D	I2SC1_CK	I/O	2	

289-ball BGA	196-ball BGA	Power Rail	I/O Type	Primary		Alternate		PIO Peripheral				Reset State (Signal, Dir, PU, PD, HiZ, ST)[1]
				Signal	Dir	Signal	Dir	Func	Signal	Dir	IO Set	
								C	TD1	O	2	
								D	I2SC1_WS	I/O	1	
								E	QSPI1_IO0	I/O	3	
								F	GRXDV	I	3	
C4	A5	VDDIOP0	GPIO_IO	PB17	I/O	–	–	A	LCDDAT6	O	1	PIO, I, PU, ST
								B	A6	O	1	
								C	RD1	I	2	
								D	I2SC1_DI0	I	1	
								E	QSPI1_IO1	I/O	3	
								F	GRXER	I	3	
A5	B4	VDDIOP0	GPIO_IO	PB18	I/O	–	–	A	LCDDAT7	O	1	PIO, I, PU, ST
								B	A7	O	1	
								C	RK1	I/O	2	
								D	I2SC1_DO0	O	1	
								E	QSPI1_IO2	I/O	3	
								F	GRX0	I	3	
B4	A6	VDDIOP0	GPIO_IO	PB19	I/O	–	–	A	LCDDAT8	O	1	PIO, I, PU, ST
								B	A8	O	1	
								C	RF1	I/O	2	
								D	TIOA3	I/O	2	
								E	QSPI1_IO3	I/O	3	
								F	GRX1	I	3	
A4	A4	VDDIOP0	GPIO	PB20	I/O	–	–	A	LCDDAT9	O	1	PIO, I, PU, ST
								B	A9	O	1	
								C	TK0	I/O	1	
								D	TIOB3	I/O	2	
								E	PCK1	O	4	
								F	GTX0	O	3	
D3	A3	VDDIOP0	GPIO	PB21	I/O	–	–	A	LCDDAT10	O	1	PIO, I, PU, ST
								B	A10	O	1	
								C	TF0	I/O	1	
								D	TCLK3	I	2	
								E	FLEXCOM3_IO2	I/O	3	
								F	GTX1	O	3	
C3	D3	VDDIOP0	GPIO	PB22	I/O	–	–	A	LCDDAT11	O	1	PIO, I, PU, ST
								B	A11	O	1	
								C	TD0	O	1	
								D	TIOA2	I/O	2	
								E	FLEXCOM3_IO1	I/O	3	
								F	GMDC	O	3	
B3	B2	VDDIOP0	GPIO	PB23	I/O	–	–	A	LCDDAT12	O	1	PIO, I, PU, ST

289-ball BGA	196-ball BGA	Power Rail	I/O Type	Primary		Alternate		PIO Peripheral				Reset State (Signal, Dir, PU, PD, HiZ, ST)[1]
				Signal	Dir	Signal	Dir	Func	Signal	Dir	IO Set	
								B	A12	O	1	
								C	RD0	I	1	
								D	TIOB2	I/O	2	
								E	FLEXCOM3_IO0	I/O	3	
								F	GMDIO	I/O	3	
E2	E3	VDDIOP0	GPIO	PB24	I/O	–	–	A	LCDDAT13	O	1	PIO, I, PU, ST
								B	A13	O	1	
								C	RK0	I/O	1	
								D	TCLK2	I	2	
								E	FLEXCOM3_IO3	O	3	
								F	ISC_D10	I	3	
A3	E2	VDDIOP0	GPIO	PB25	I/O	–	–	A	LCDDAT14	O	1	PIO, I, PU, ST
								B	A14	O	1	
								C	RF0	I/O	1	
								E	FLEXCOM3_IO4	O	3	
								F	ISC_D11	I	3	
G3	D4	VDDIOP0	GPIO	PB26	I/O	–	–	A	LCDDAT15	O	1	PIO, I, PU, ST
								B	A15	O	1	
								C	URXD0	I	1	
								D	PDMIC_DAT		1	
								F	ISC_D0	I	3	
F4	C3	VDDIOP0	GPIO	PB27	I/O	–	–	A	LCDDAT16	O	1	PIO, I, PU, ST
								B	A16	O	1	
								C	UTXD0	O	1	
								D	PDMIC_CLK		1	
								F	ISC_D1	I	3	
D2	D2	VDDIOP0	GPIO	PB28	I/O	–	–	A	LCDDAT17	O	1	PIO, I, PU, ST
								B	A17	O	1	
								C	FLEXCOM0_IO0	I/O	1	
								D	TIOA5	I/O	2	
								F	ISC_D2	I	3	
G8	B3	VDDIOP0	GPIO	PB29	I/O	–	–	A	LCDDAT18	O	1	PIO, I, PU, ST
								B	A18	O	1	
								C	FLEXCOM0_IO1	I/O	1	
								D	TIOB5	I/O	2	
								F	ISC_D3	I	3	
C2	F3	VDDIOP0	GPIO	PB30	I/O	–	–	A	LCDDAT19	O	1	PIO, I, PU, ST
								B	A19	O	1	
								C	FLEXCOM0_IO2	I/O	1	
								D	TCLK5	I	2	
								F	ISC_D4	I	3	

289-ball BGA	196-ball BGA	Power Rail	I/O Type	Primary		Alternate		PIO Peripheral				Reset State (Signal, Dir, PU, PD, HiZ, ST)[1]
				Signal	Dir	Signal	Dir	Func	Signal	Dir	IO Set	
G7	A2	VDDIOP0	GPIO	PB31	I/O	–	–	A	LCDDAT20	O	1	PIO, I, PU, ST
								B	A20	O	1	
								C	FLEXCOM0_IO3	O	1	
								D	TWD0	I/O	1	
								F	ISC_D5	I	3	
N10	L13	VDDIOP1	GPIO	PC0	I/O	–	–	A	LCDDAT21	O	1	PIO, I, PU, ST
								B	A23	O	1	
								C	FLEXCOM0_IO4	O	1	
								D	TWCK0	I/O	1	
								F	ISC_D6	I	3	
N11	H11	VDDIOP1	GPIO	PC1	I/O	–	–	A	LCDDAT22	O	1	PIO, I, PU, ST
								B	A24	O	1	
								C	CANTX0	O	1	
								D	SPI1_SPCK	I/O	1	
								E	I2SC0_CK	I/O	1	
								F	ISC_D7	I	3	
N9	L11	VDDIOP1	GPIO	PC2	I/O	–	–	A	LCDDAT23	O	1	PIO, I, PU, ST
								B	A25	O	1	
								C	CANRX0	I	1	
								D	SPI1_MOSI	I/O	1	
								E	I2SC0_MCK	O	1	
								F	ISC_D8	I	3	
M10	F13	VDDIOP1	GPIO	PC3	I/O	–	–	A	LCDPWM	O	1	PIO, I, PU, ST
								B	NWAIT	I	1	
								C	TIOA1	I/O	1	
								D	SPI1_MISO	I/O	1	
								E	I2SC0_WS	I/O	1	
								F	ISC_D9	I	3	
N15	G14	VDDIOP1	GPIO	PC4	I/O	–	–	A	LCDDISP	O	1	PIO, I, PU, ST
								B	NWR1/NBS1	O	1	
								C	TIOB1	I/O	1	
								D	SPI1_NPCS0	I/O	1	
								E	I2SC0_DI0	I	1	
								F	ISC_PCK	I	3	
M16	J14	VDDIOP1	GPIO	PC5	I/O	–	–	A	LCDVSYNC	O	1	PIO, I, PU, ST
								B	NCS0	O	1	
								C	TCLK1	I	1	
								D	SPI1_NPCS1	O	1	
								E	I2SC0_DO0	O	1	
								F	ISC_VSYNC	I	3	
L11	J13	VDDIOP1	GPIO	PC6	I/O	–	–	A	LCDHSYNC	O	1	PIO, I, PU, ST

289-ball BGA	196-ball BGA	Power Rail	I/O Type	Primary		Alternate		PIO Peripheral				Reset State (Signal, Dir, PU, PD, HiZ, ST)[1]
				Signal	Dir	Signal	Dir	Func	Signal	Dir	IO Set	
								B	NCS1	O	1	
								C	TWD1	I/O	1	
								D	SPI1_NPCS2	O	1	
								F	ISC_HSYNC	I	3	
M15	F14	VDDIOP1	GPIO_CLK	PC7	I/O	–	–	A	LCDPCK	O	1	PIO, I, PU, ST
								B	NCS2	O	1	
								C	TWCK1	I/O	1	
								D	SPI1_NPCS3	O	1	
								E	URXD1	I	2	
								F	ISC_MCK	O	3	
M13	K13	VDDIOP1	GPIO	PC8	I/O	–	–	A	LCDDEN	O	1	PIO, I, PU, ST
								B	NANDRDY	I	1	
								C	FIQ	I	1	
								D	PCK0	O	3	
								E	UTXD1	O	2	
								F	ISC_FIELD	I	3	
B2	–	VDDISC	GPIO	PC9	I/O	–	–	A	FIQ	I	3	PIO, I, PU, ST
								B	GTSUCOMP	O	1	
								C	ISC_D0	I	1	
								D	TIOA4	I/O	2	
G4	–	VDDISC	GPIO	PC10	I/O	–	–	A	LCDDAT2	O	2	PIO, I, PU, ST
								B	GTXCK	I/O	1	
								C	ISC_D1	I	1	
								D	TIOB4	I/O	2	
								E	CANTX0	O	2	
A2	–	VDDISC	GPIO	PC11	I/O	–	–	A	LCDDAT3	O	2	PIO, I, PU, ST
								B	GTXEN	O	1	
								C	ISC_D2	I	1	
								D	TCLK4	I	2	
								E	CANRX0	I	2	
								F	A0/NBS0	O	2	
A1	–	VDDISC	GPIO	PC12	I/O	–	–	A	LCDDAT4	O	2	PIO, I, PU, ST
								B	GRXDV	I	1	
								C	ISC_D3	I	1	
								D	URXD3	I	1	
								E	TK0	I/O	2	
								F	A1	O	2	
B1	–	VDDISC	GPIO	PC13	I/O	–	–	A	LCDDAT5	O	2	PIO, I, PU, ST
								B	GRXER	I	1	
								C	ISC_D4	I	1	
								D	UTXD3	O	1	

289-ball BGA	196-ball BGA	Power Rail	I/O Type	Primary		Alternate		PIO Peripheral				Reset State (Signal, Dir, PU, PD, HiZ, ST)[1]
				Signal	Dir	Signal	Dir	Func	Signal	Dir	IO Set	
								E	TF0	I/O	2	
								F	A2	O	2	
G5	–	VDDISC	GPIO	PC14	I/O	–	–	A	LCDDAT6	O	2	PIO, I, PU, ST
								B	GRX0	I	1	
								C	ISC_D5	I	1	
								E	TD0	O	2	
								F	A3	O	2	
G2	–	VDDISC	GPIO	PC15	I/O	–	–	A	LCDDAT7	O	2	PIO, I, PU, ST
								B	GRX1	I	1	
								C	ISC_D6	I	1	
								E	RD0	I	2	
								F	A4	O	2	
G6	–	VDDISC	GPIO	PC16	I/O	–	–	A	LCDDAT10	O	2	PIO, I, PU, ST
								B	GTX0	O	1	
								C	ISC_D7	I	1	
								E	RK0	I/O	2	
								F	A5	O	2	
C1	–	VDDISC	GPIO	PC17	I/O	–	–	A	LCDDAT11	O	2	PIO, I, PU, ST
								B	GTX1	O	1	
								C	ISC_D8	I	1	
								E	RF0	I/O	2	
								F	A6	O	2	
G9	–	VDDISC	GPIO	PC18	I/O	–	–	A	LCDDAT12	O	2	PIO, I, PU, ST
								B	GMDC	O	1	
								C	ISC_D9	I	1	
								E	FLEXCOM3_IO2	I/O	2	
								F	A7	O	2	
D1	–	VDDISC	GPIO	PC19	I/O	–	–	A	LCDDAT13	O	2	PIO, I, PU, ST
								B	GMDIO	I/O	1	
								C	ISC_D10	I	1	
								E	FLEXCOM3_IO1	I/O	2	
								F	A8	O	2	
H4	–	VDDISC	GPIO	PC20	I/O	–	–	A	LCDDAT14	O	2	PIO, I, PU, ST
								B	GRXCK	I	1	
								C	ISC_D11	I	1	
								E	FLEXCOM3_IO0	I/O	2	
								F	A9	O	2	
E1	–	VDDISC	GPIO	PC21	I/O	–	–	A	LCDDAT15	O	2	PIO, I, PU, ST
								B	GTXER	O	1	
								C	ISC_PCK	I	1	
								E	FLEXCOM3_IO3	O	2	

289-ball BGA	196-ball BGA	Power Rail	I/O Type	Primary		Alternate		PIO Peripheral				Reset State (Signal, Dir, PU, PD, HiZ, ST)[1]
				Signal	Dir	Signal	Dir	Func	Signal	Dir	IO Set	
								F	A10	O	2	
F1	–	VDDISC	GPIO	PC22	I/O	–	–	A	LCDDAT18	O	2	PIO, I, PU, ST
								B	GCRS	I	1	
								C	ISC_VSYNC	I	1	
								E	FLEXCOM3_IO4	O	2	
								F	A11	O	2	
H9	–	VDDISC	GPIO	PC23	I/O	–	–	A	LCDDAT19	O	2	PIO, I, PU, ST
								B	GCOL	I	1	
								C	ISC_HSYNC	I	1	
								F	A12	O	2	
G1	–	VDDISC	GPIO_CLK	PC24	I/O	–	–	A	LCDDAT20	O	2	PIO, I, PU, ST
								B	GRX2	I	1	
								C	ISC_MCK	O	1	
								F	A13	O	2	
H8	–	VDDISC	GPIO	PC25	I/O	–	–	A	LCDDAT21	O	2	PIO, I, PU, ST
								B	GRX3	I	1	
								C	ISC_FIELD	I	1	
								F	A14	O	2	
F7	–	VDDIOP2	GPIO	PC26	I/O	–	–	A	LCDDAT22	O	2	PIO, I, PU, ST
								B	GTX2	O	1	
								D	CANTX1	O	1	
								F	A15	O	2	
B10	–	VDDIOP2	GPIO	PC27	I/O	–	–	A	LCDDAT23	O	2	PIO, I, PU, ST
								B	GTX3	O	1	
								C	PCK1	O	2	
								D	CANRX1	I	1	
								E	TWD0	I/O	2	
								F	A16	O	2	
F6	–	VDDIOP2	GPIO	PC28	I/O	–	–	A	LCDPWM	O	2	PIO, I, PU, ST
								B	FLEXCOM4_IO0	I/O	1	
								C	PCK2	O	1	
								E	TWCK0	I/O	2	
								F	A17	O	2	
B9	–	VDDIOP2	GPIO	PC29	I/O	–	–	A	LCDDISP	O	2	PIO, I, PU, ST
								B	FLEXCOM4_IO1	I/O	1	
								F	A18	O	2	
E6	–	VDDIOP2	GPIO	PC30	I/O	–	–	A	LCDVSYNC	O	2	PIO, I, PU, ST
								B	FLEXCOM4_IO2	I/O	1	
								F	A19	O	2	
A11	–	VDDIOP2	GPIO	PC31	I/O	–	–	A	LCDHSYNC	O	2	PIO, I, PU, ST
								B	FLEXCOM4_IO3	O	1	

289-ball BGA	196-ball BGA	Power Rail	I/O Type	Primary		Alternate		PIO Peripheral				Reset State (Signal, Dir, PU, PD, HiZ, ST)[1]
				Signal	Dir	Signal	Dir	Func	Signal	Dir	IO Set	
								C	URXD3	I	2	
								F	A20	O	2	
E7	–	VDDIOP2	GPIO_CLK	PD0	I/O	–	–	A	LCDPCK	O	2	PIO, I, PU, ST
								B	FLEXCOM4_IO4	O	1	
								C	UTXD3	O	2	
								D	GTSUCOMP	O	2	
								F	A23	O	2	
C9	–	VDDIOP2	GPIO	PD1	I/O	–	–	A	LCDDEN	O	2	PIO, I, PU, ST
								D	GRXCK	I	2	
								F	A24	O	2	
D8	–	VDDIOP2	GPIO_CLK	PD2	I/O	–	–	A	URXD1	I	1	PIO, I, PU, ST
								D	GTXER	O	2	
								E	ISC_MCK	O	2	
								F	A25	O	2	
J1	–	VDDANA	GPIO_AD	PD3	I/O	–	–	A	UTXD1	O	1	PIO, I, PU, ST
								B	FIQ	I	2	
								D	GCRS	I	2	
								E	ISC_D11	I	2	
								F	NWAIT	I	2	
H7	–	VDDANA	GPIO_AD	PD4	I/O	–	–	A	TWD1	I/O	2	PIO, I, PU, ST
								B	URXD2	I	1	
								D	GCOL	I	2	
								E	ISC_D10	I	2	
								F	NCS0	O	2	
H1	–	VDDANA	GPIO_AD	PD5	I/O	–	–	A	TWCK1	I/O	2	PIO, I, PU, ST
								B	UTXD2	O	1	
								D	GRX2	I	2	
								E	ISC_D9	I	2	
								F	NCS1	O	2	
J2	–	VDDANA	GPIO_AD	PD6	I/O	–	–	A	TCK	I	2	PIO, I, PU, ST
								B	PCK1	O	1	
								D	GRX3	I	2	
								E	ISC_D8	I	2	
								F	NCS2	O	2	
H6	H5	VDDANA	GPIO_AD	PD7	I/O	–	–	A	TDI	I	2	PIO, I, PU, ST
								C	UTMI_RXVAL	O	1	
								D	GTX2	O	2	
								E	ISC_D0	I	2	
								F	NWR1/NBS1	O	2	
K3	J2	VDDANA	GPIO_AD	PD8	I/O	–	–	A	TDO	O	2	PIO, I, PU, ST
								C	UTMI_RXERR	O	1	

289-ball BGA	196-ball BGA	Power Rail	I/O Type	Primary		Alternate		PIO Peripheral				Reset State (Signal, Dir, PU, PD, HiZ, ST)[1]
				Signal	Dir	Signal	Dir	Func	Signal	Dir	IO Set	
L1	J1	VDDANA	GPIO_AD	PD16	I/O	–	–	A	TDO	O	1	PIO, I, PU, ST
								B	FLEXCOM4_IO4	O	2	
								C	UTMI_CDRBISTEN	I	1	
								D	GTX1	O	2	
								E	ISC_VSYNC	I	2	
								F	ISC_D8	I	4	
K1	A1	VDDANA	GPIO_AD	PD17	I/O	–	–	A	TMS	I	1	A, PU, ST
								C	UTMI_CDRCPSELDIV	O	1	
								D	GMDC	O	2	
								E	ISC_HSYNC	I	2	
								F	ISC_D9	I	4	
J7	G3	VDDANA	GPIO_AD	PD18	I/O	–	–	A	NTRST	I	1	PIO, I, PU, ST
								D	GMDIO	I/O	2	
								E	ISC_FIELD	I	2	
								F	ISC_D10	I	4	
L8	K2	VDDANA	GPIO_AD	PD19	I/O	AD0	–	A	PCK0	O	1	PIO, I, PU, ST
								B	TWD1	I/O	3	
								C	URXD2	I	3	
								E	I2SC0_CK	I/O	2	
								F	ISC_D11	I	4	
L2	H1	VDDANA	GPIO_AD	PD20	I/O	AD1	–	A	TIOA2	I/O	3	PIO, I, PU, ST
								B	TWCK1	I/O	3	
								C	UTXD2	O	3	
								E	I2SC0_MCK	O	2	
								F	ISC_PCK	I	4	
P1	G1	VDDANA	GPIO_AD	PD21	I/O	AD2	–	A	TIOB2	I/O	3	PIO, I, PU, ST
								B	TWD0	I/O	4	
								C	FLEXCOM4_IO0	I/O	3	
								E	I2SC0_WS	I/O	2	
								F	ISC_VSYNC	I	4	
L6	F1	VDDANA	GPIO_AD	PD22	I/O	AD3	–	A	TCLK2	I	3	PIO, I, PU, ST
								B	TWCK0	I/O	4	
								C	FLEXCOM4_IO1	I/O	3	
								E	I2SC0_DI0	I	2	
								F	ISC_HSYNC	I	4	
T1	E1	VDDANA	GPIO_AD	PD23	I/O	AD4	–	A	URXD2	I	2	PIO, I, PU, ST
								C	FLEXCOM4_IO2	I/O	3	
								E	I2SC0_DO0	O	2	
								F	ISC_FIELD	I	4	
L4	–	VDDANA	GPIO_AD	PD24	I/O	AD5	–	A	UTXD2	O	2	PIO, I, PU, ST
								C	FLEXCOM4_IO3	O	3	

289-ball BGA	196-ball BGA	Power Rail	I/O Type	Primary		Alternate		PIO Peripheral				Reset State (Signal, Dir, PU, PD, HiZ, ST)[1]
				Signal	Dir	Signal	Dir	Func	Signal	Dir	IO Set	
N3	–	VDDBU	–	PIOBU7	–	–	–	–	–	–	–	–
U5	K5	VDDBU	power	VDDBU	I	–	–	–	–	–	–	–
U4	N2	GNDBU	ground	GNDBU	I	–	–	–	–	–	–	–
U2	M1	VDDBU	–	XIN32	–	–	–	–	–	–	–	–
U1	M2	VDDBU	–	XOUT32	–	–	–	–	–	–	–	–
U6	P2	VDDBU	–	COMPP	I	–	–	–	–	–	–	–
U7	P3	VDDBU	–	COMPN	I	–	–	–	–	–	–	–
D17	D12	DDRM_VDDQ[2]	–	ODT	I	–	–	–	–	–	–	–
A16, B16, C16, D16, E15, G17, J17, L16	B10, A12, D10, D11	DDRM_VDD	power	DDRM_VDD	I	–	–	–	–	–	–	–
E16	E7	DDRM_VDDL[2]	power	DDRM_VDDL[2]	I	–	–	–	–	–	–	–
F15, G15, H15, J15, K15, L15	A7, A13, A9, A11, B6, C12	DDRM_VDDQ[2]	power	DDRM_VDDQ[2]	–	–	–	–	–	–	–	–
A17, B17, C17, D15, E14, F17, H17, L17	B14, A8, C11, C14, D8	DDRM_VSS	ground	DDRM_VSS	–	–	–	–	–	–	–	–
E17	D13	DDRM_VSSDL	ground	DDRM_VSSDL	I	–	–	–	–	–	–	–
F16, G16, H16, J16, K16, K17	A10, A14, B11, B12, B13, C13	DDRM_VSSQ	ground	DDRM_VSSQ	I	–	–	–	–	–	–	–
A12, A13, A14, A15, B11, B12, B13, B14, B15, C10, C11, C12, C13, C14, C15, D10, D11, D12, D13, D14, E13, F9, F10, F13, F14, G11, G13, G14, H11, H13, H14, J12, J13, J14, K12, K13, K14, L13, R12, T9	–	–	NC	–	–	–	–	–	–	–	–	–

Note:

1. Signal = ‘PIO’ if GPIO; Dir = Direction; PU = Pull-up; PD = Pull-down; HiZ = High impedance; ST = Schmitt Trigger
2. Refer to the DDR2-SDRAM datasheet for DDRM_VDDQ and DDRM_VDDL definitions. DDRM_VDDQ/DDRM_VDDL = 1.8V ±0.1V.

8. Ordering Information

Table 8-1. Ordering Information

Ordering Code	MRL	Package	Carrier Type	Operating Temperature Range
ATSAMA5D225C-D1M-CU	C	BGA196	Tray	-40°C to +85°C
ATSAMA5D225C-D1M-CUR			Tape & Reel	
ATSAMA5D27C-D5M-CU		BGA289	Tray	
ATSAMA5D27C-D5M-CUR			Tape & Reel	
ATSAMA5D27C-D1G-CU			Tray	
ATSAMA5D27C-D1G-CUR			Tape & Reel	
ATSAMA5D28C-D1G-CU			Tray	
ATSAMA5D28C-D1G-CUR			Tape & Reel	

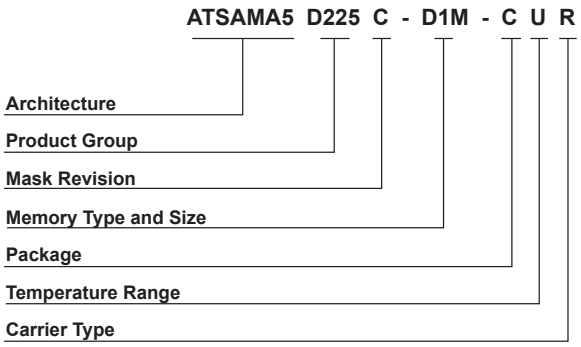
9. Revision History

Table 9-1. SAMA5D2 SIP Datasheet, DS60001484A, September-2017 Revision History

Changes
First issue.

Product Identification System

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.



Architecture:	ATSAMA5	= ARM Cortex-A5 CPU
Product Group:	D225	= 196-ball general-purpose microprocessor family
	D27	= 289-ball general-purpose microprocessor family
	D28	
Memory Type and Size:	D1M	= 128-Mbit DDR2 SDRAM
	D5M	= 512-Mbit DDR2 SDRAM
	D1G	= 1-Gigabit DDR2 SDRAM
Mask Revision:	C	
Package:	C	= BGA
Temperature Range:	U	= -40°C to +85°C (Industrial)
Carrier Type:	Blank	= Standard packaging (tray)
	R	= Tape and Reel

Examples:

- ATSAMA5D225C-D1M-CU = ARM Cortex-A5 general-purpose microprocessor, 128-Mbit DDR2 SDRAM, 196-ball, Industrial temperature, BGA Package.

Note: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package

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